Device Selection Guide

Code	Chip Materials	Emitted Color	Resin Color
R6	AlGaInP	Brilliant Red	White Diffused
GH	InGaN	Brilliant Green	
BH	InGaN	Blue	

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Code	Rating	Unit
Reverse Voltage	V_R		5	V
Forward Current	I_F		25	mA
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	R6	60	mA
		GH	100	
		BH	100	
Power Dissipation	Pd	R6	60	mW
		GH	95	
		BH	95	
Electrostatic Discharge(HBM)	ESD	R6	2000	V
		GH	150	
		BH	150	
Operating Temperature	T_{opr}		-40 ~ +85	℃
Storage Temperature	Tstg		-40 ~ +90	℃
Soldering Temperature	Tsol		Reflow Soldering : 260 ℃ for 10 sec. Hand Soldering : 350 ℃ for 3 sec.	

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Code	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	Iv		36.0	-----	90.0	mcd	
Viewing Angle	$2\theta_{1/2}$		-----	120	-----	Deg	
Peak Wavelength	λ p	R6	-----	632	-----	nm	
		GH	-----	518	-----		
		BH	-----	468	-----		
Dominant Wavelength	λ d	R6	-----	624	-----	nm	R6：IF=4.0mA GH：IF=1.5mA BH：IF=2.0mA
		GH	-----	525	-----		
		BH	-----	470	-----		
Spectrum Radiation Bandwidth	△λ	R6	-----	20	-----	nm	
		GH	-----	35	-----		
		BH	-----	25	-----		
Forward Voltage	V_F	R6	1.6	-----	2.0	V	
		GH	2.4	-----	2.9		
		BH	2.5	-----	3.0		
Reverse Current	I_R	R6			10	μA	V_R=5V
		GH			50		
		BH	-----	-----	50		

Note:
1. Tolerance of Luminous Intensity: ±11%
2. Tolerance of Forward Voltage: ±0.1V

Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
N2	36	45	mcd	R6：IF=4.0mA GH：IF=1.5mA BH：IF=2.0mA
P1	45	57		
P2	57	72		
Q1	72	90		

Note:
1. Tolerance of Luminous Intensity: ±11%

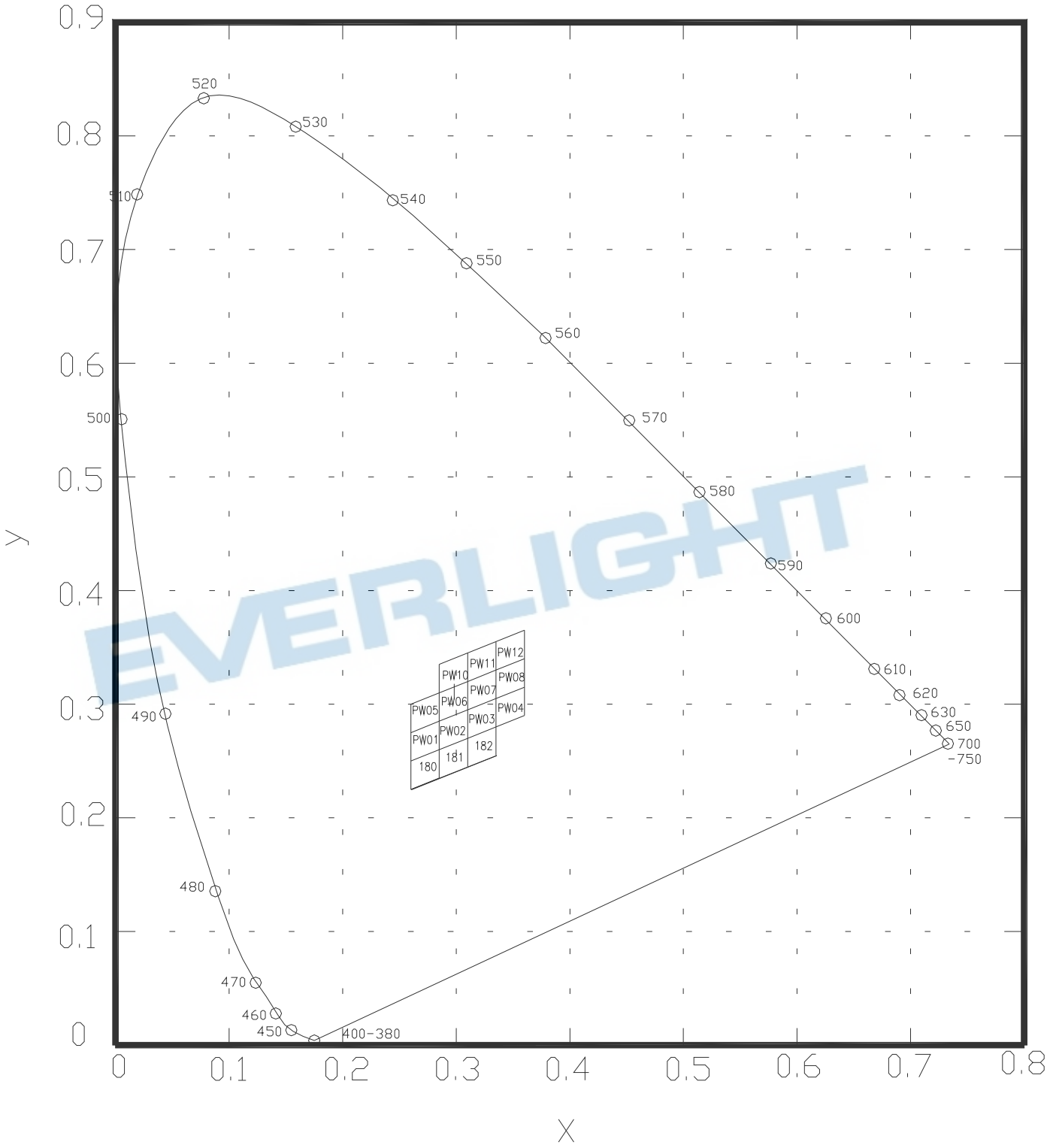
Chromaticity Coordinates Specifications for Bin Grading

Bin Code	CIE_x	CIE_y	Condition
180	0.257	0.220	R6：IF=4.0mA GH：IF=1.5mA BH：IF=2.0mA
	0.257	0.245	
	0.282	0.255	
	0.282	0.230	
181	0.282	0.230	
	0.282	0.255	
	0.307	0.265	
	0.307	0.240	
182	0.307	0.240	
	0.307	0.265	
	0.332	0.275	
	0.332	0.250	
PW 01	0.257	0.245	
	0.257	0.270	
	0.282	0.280	
	0.282	0.255	
PW 02	0.282	0.255	
	0.282	0.280	
	0.307	0.290	
	0.307	0.265	
PW 03	0.307	0.265	
	0.307	0.290	
	0.332	0.300	
	0.332	0.275	

Bin Code	CIE_x	CIE_y	Condition
PW 04	0.332	0.275	R6：IF=4.0mA GH：IF=1.5mA BH：IF=2.0mA
	0.332	0.300	
	0.357	0.310	
	0.357	0.285	
PW 05	0.257	0.270	
	0.257	0.295	
	0.282	0.305	
	0.282	0.280	
PW 06	0.282	0.280	
	0.282	0.305	
	0.307	0.315	
	0.307	0.290	
PW 07	0.307	0.290	
	0.307	0.315	
	0.332	0.325	
	0.332	0.300	
PW 08	0.332	0.300	
	0.332	0.325	
	0.357	0.335	
	0.357	0.310	
PW 10	0.282	0.305	
	0.282	0.330	
	0.307	0.340	
	0.307	0.315	
PW 11	0.307	0.315	
	0.307	0.340	
	0.332	0.350	
	0.332	0.325	
PW 12	0.332	0.325	
	0.332	0.350	
	0.357	0.360	
	0.357	0.335	

*When three LED dies are operated simultaneously.
Notes:
1.The C.I.E. 1931 chromaticity diagram (Tolerance ±0.01).
2.The products are sensitive to static electricity and care must be fully taken when handling products.

CIE Chromaticity Diagram

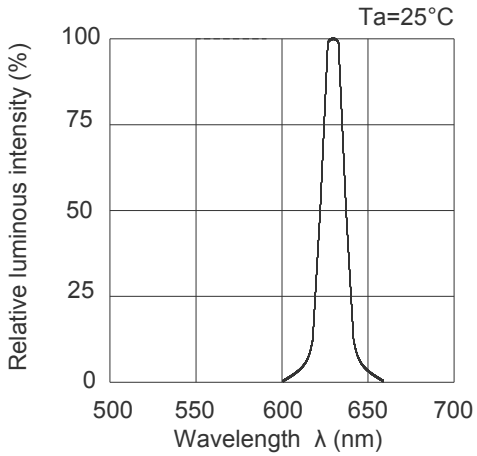


Notes:
1.The C.I.E. 1931 chromaticity diagram (Tolerance ±0.01).
2.The products are sensitive to static electricity and care must be fully taken when handling products.

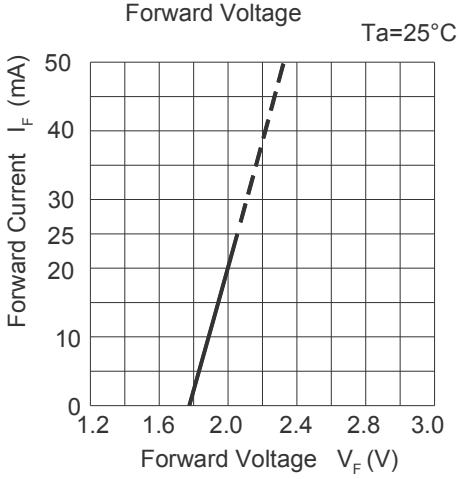
Typical Electro-Optical Characteristics Curves

R6

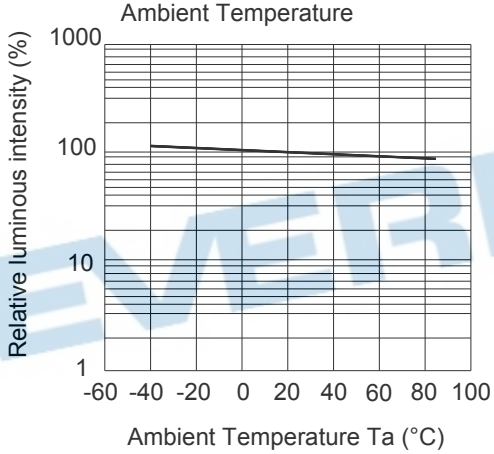
Spectrum Distribution



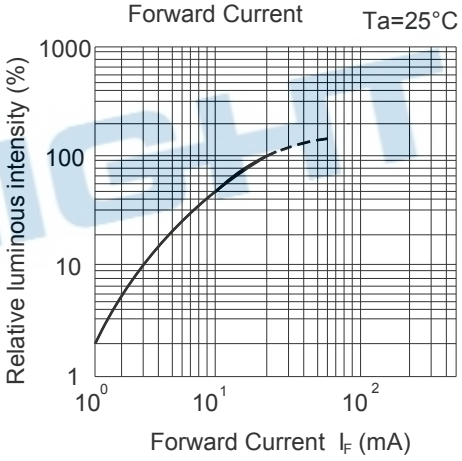
Forward Current vs. Forward Voltage



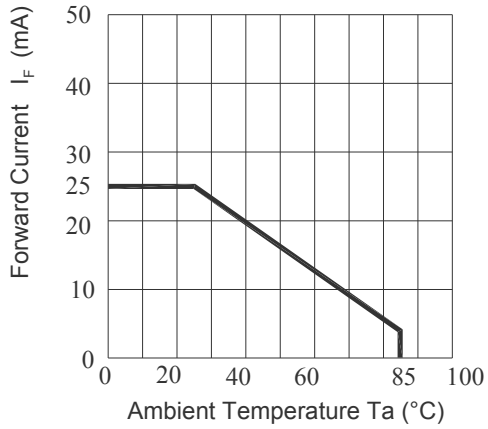
Luminous Intensity vs. Ambient Temperature



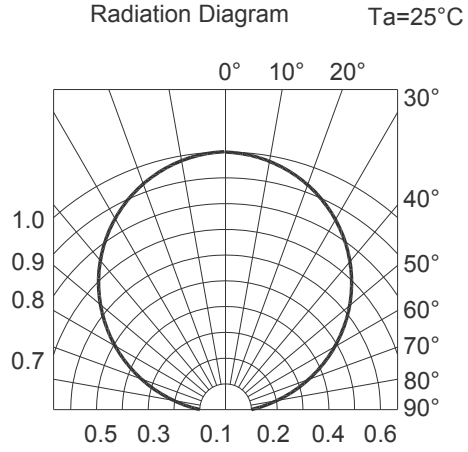
Luminous Intensity vs. Forward Current



Forward Current Derating Curve



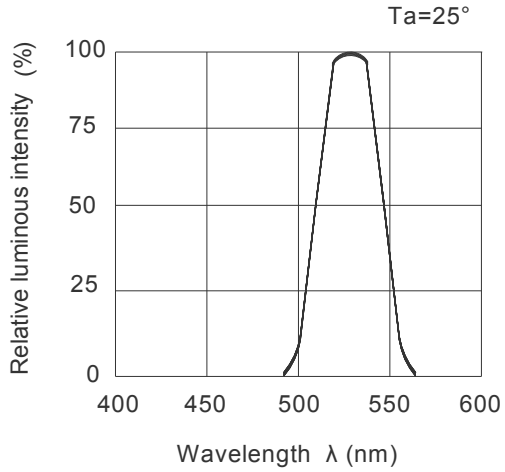
Radiation Diagram



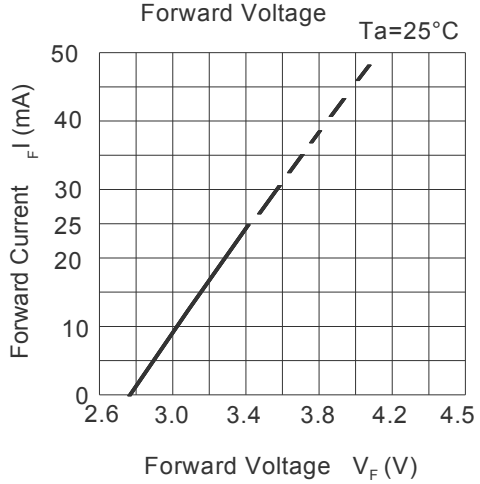
Typical Electro-Optical Characteristics Curves

GH

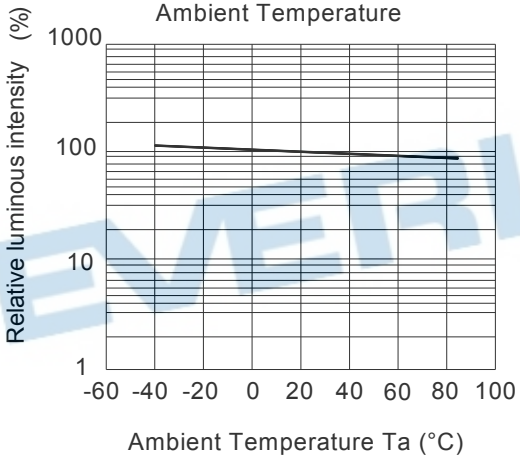
Spectrum Distribution



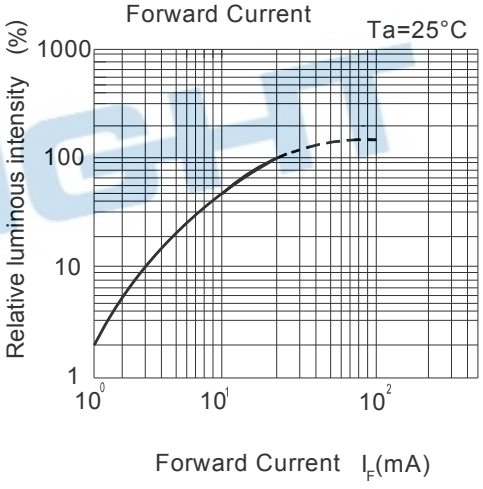
Forward Current vs. Forward Voltage



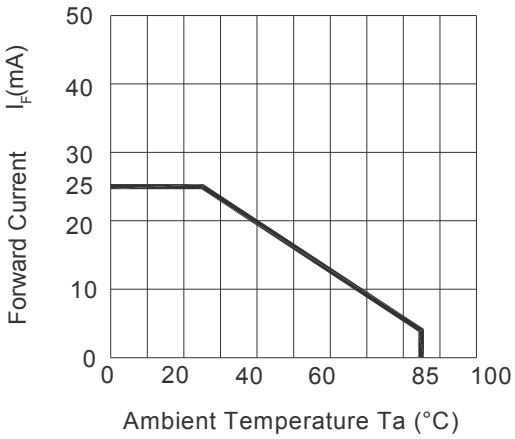
Luminous Intensity vs. Ambient Temperature



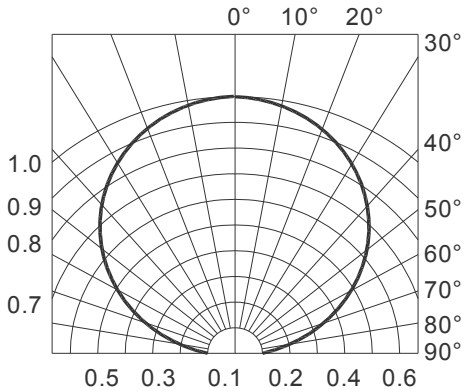
Luminous Intensity vs Forward Current



Forward Current Derating Curve



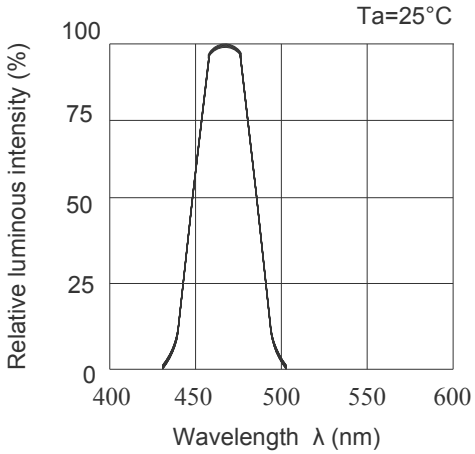
Radiation Diagram Ta=25°C



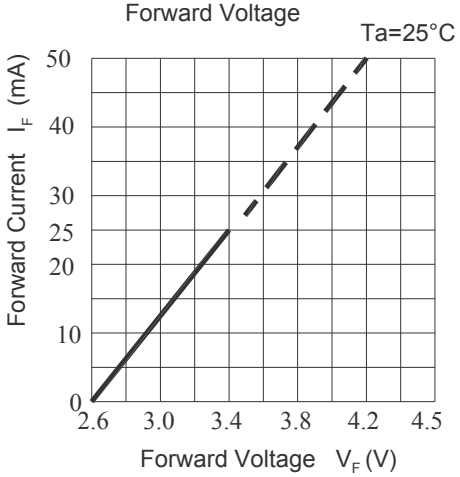
Typical Electro-Optical Characteristics Curves

BH

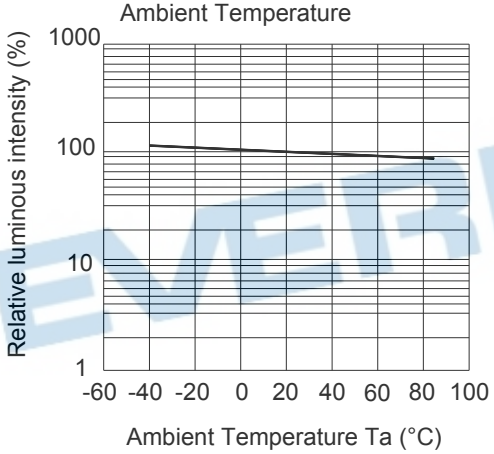
Spectrum Distribution



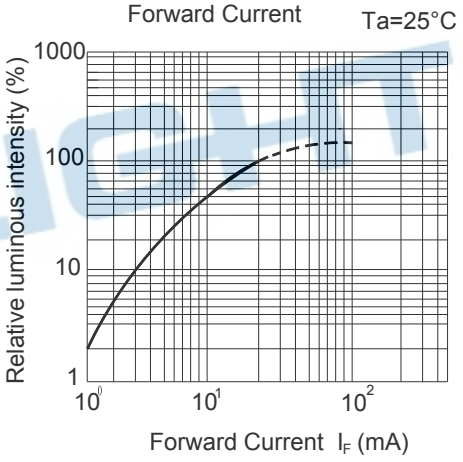
Forward Current vs. Forward Voltage



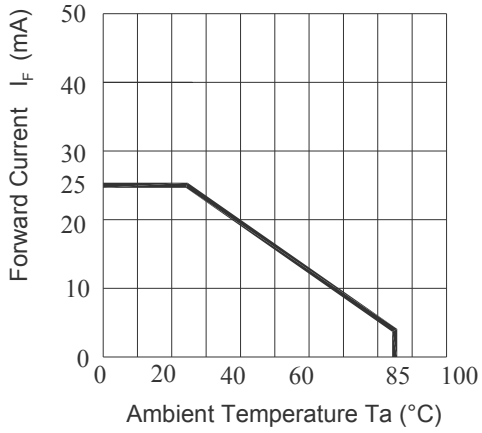
Luminous Intensity vs. Ambient Temperature



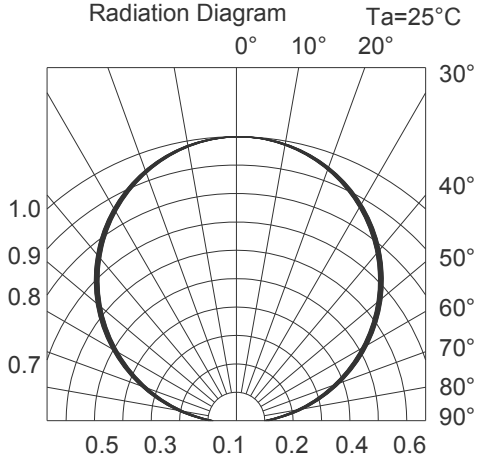
Luminous Intensity vs. Forward Current



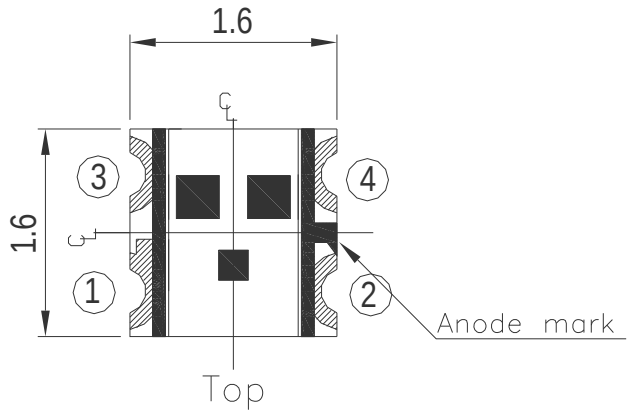
Forward Current Derating Curve

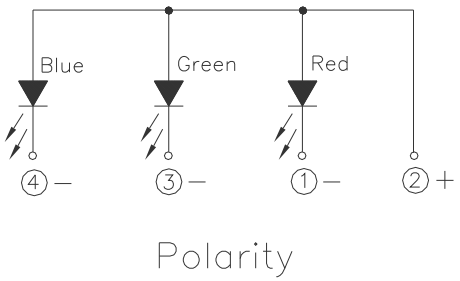


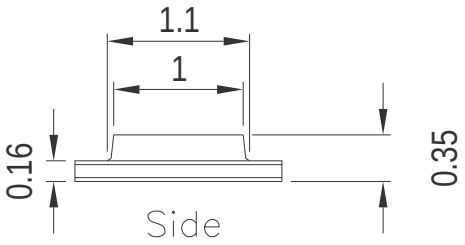
Radiation Diagram

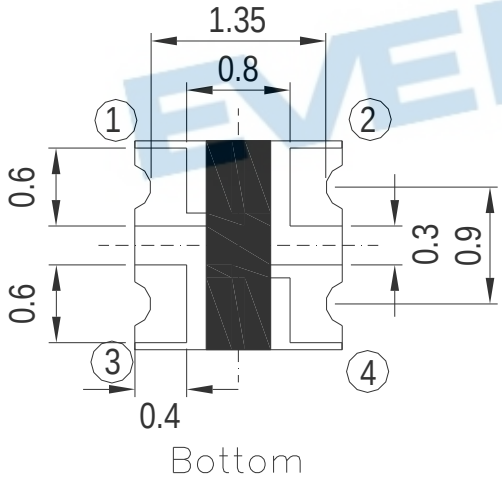


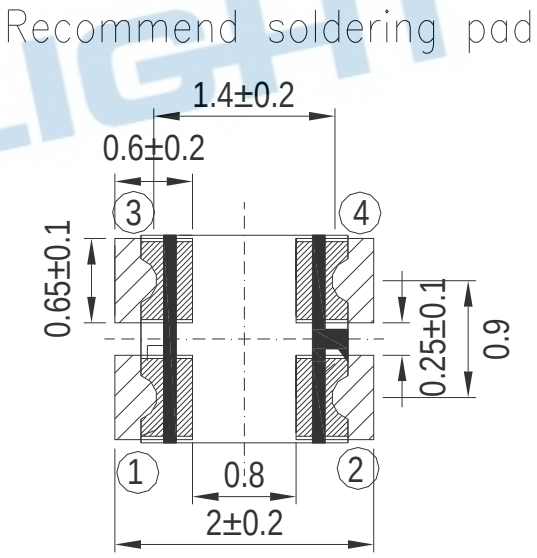
Package Dimension









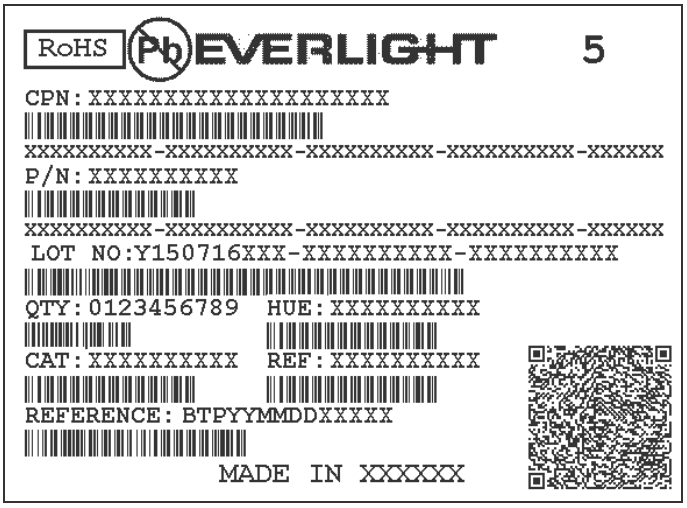


Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

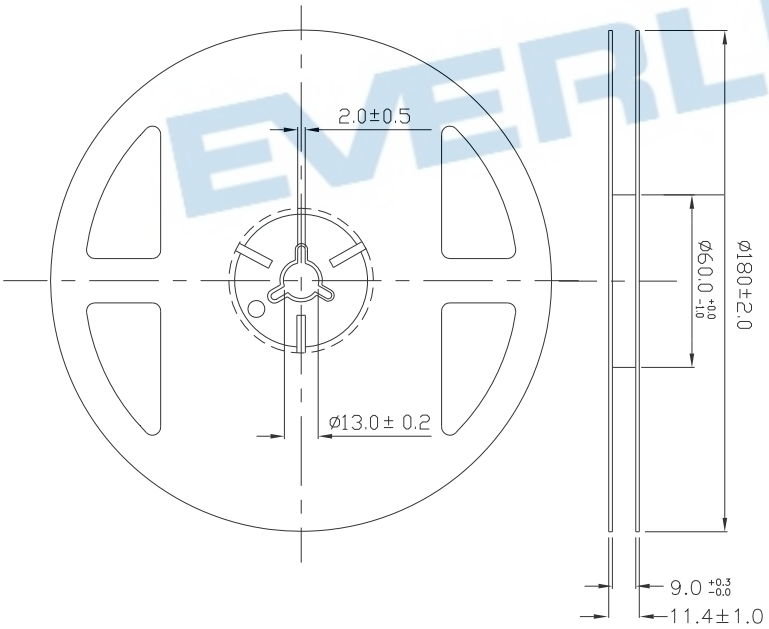
Moisture Resistant Packing Materials

Label Explanation



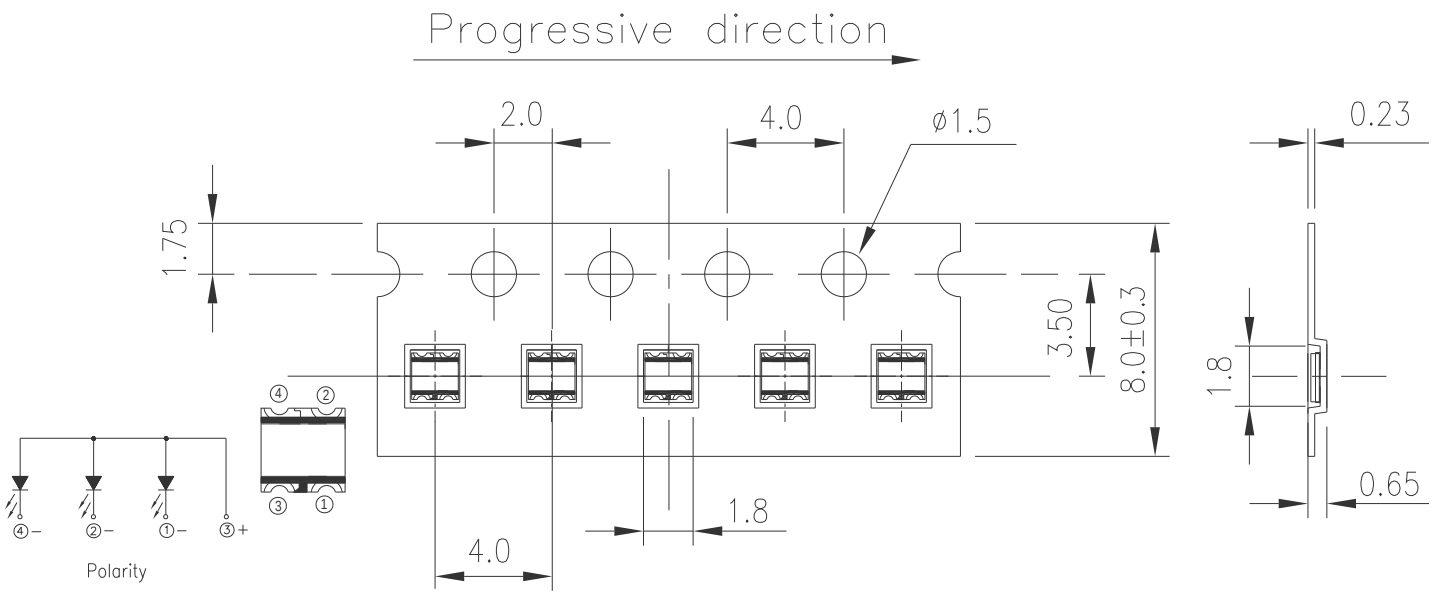
- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

Reel Dimensions



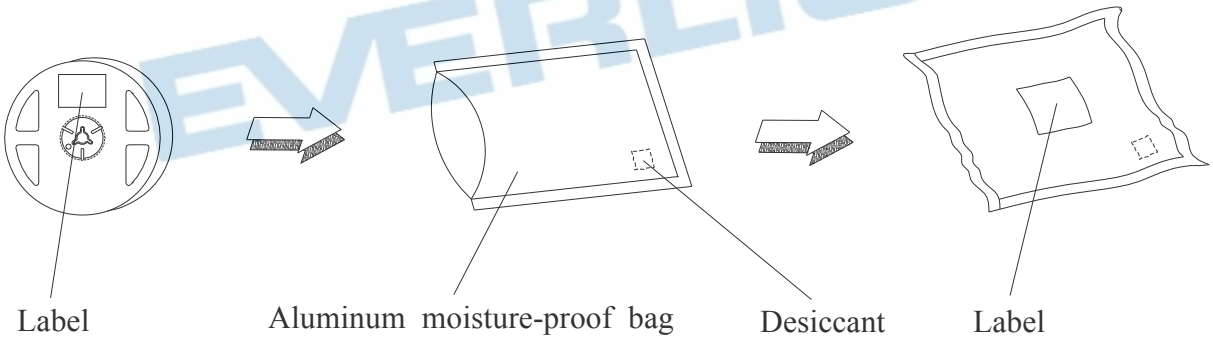
Note: The tolerances unless mentioned is ±0.1mm ,Unit = mm

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



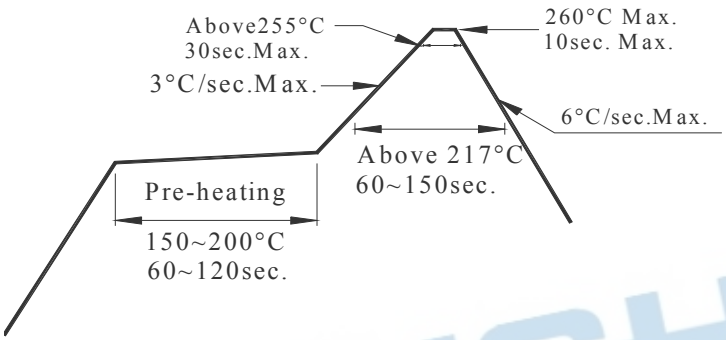
Note: The tolerances unless mentioned is ±0.1mm ,Unit = mm

Moisture Resistant Packaging



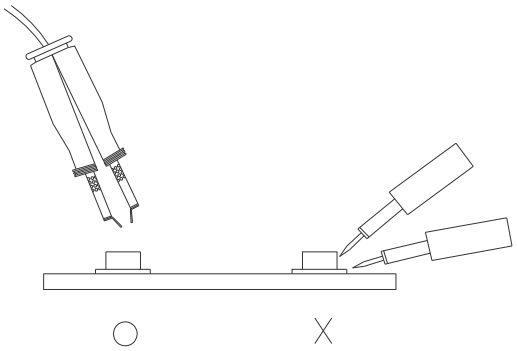
Precautions For Use

1. Over-current-proof
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).
2. Storage
2.1 Do not open moisture proof bag before the products are ready to use.
2.2 Before opening the package: The LEDs should be kept at 30℃ or less and 90%RH or less.
2.3 After opening the package: The LED's floor life is 1 year under 30℃ or less and 60% RH or less.
If unused LEDs remain, it should be stored in moisture proof packages.
2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
Baking treatment : 60±5℃ for 24 hours.
3. Soldering Condition
3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.
3.3 When soldering, do not put stress on the LEDs during heating.
3.4 After soldering, do not warp the circuit board.
4.Soldering Iron
Each terminal is to go to the tip of soldering iron temperature less than 350℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing
Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.

DISCLAIMER

1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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